

# **TYPICAL PROPERTIES & SPECIFICATIONS SHEET**

conductive containers, inc.

**DESCRIPTION:** Inherently Dissipative TPU Permanent **APPLICATION:** Thermoforming

Long Term Use

## CCI PART NUMBER: KleanStat Flex TPU

PROPERTY	VALUE (U.S.)	TEST METHOD
Volume Resistivity	10 <sup>6</sup> - 10 <sup>9</sup> Ohms/cm	ESD S11.12
Surface Resistance	10 <sup>6</sup> -10 <sup>9</sup> Ohms/sq	ESD S11.11(12% RH)
Static Decay Rate (+5000V-50V)	0.01 Sec	FTMS 101-C (12% RH)
Static Decay Rate (-5000V-50V)	0.01 Sec	FTMS 101-C (12% RH)
Static Decay Rate (+1000V-100V)	0.1 Sec	FTMS 101-C (12% RH)
Host Polymer	TPU	
Filler	IDP	
Color	Transparent	Visual
Specific Gravity	1.16 g/cc	ASTM D-792
Tensile Modulus (@ 100%)	1,200 psi	ASTM D-412
Tensile Modulus (@ 300%)	2,200 psi	ASTM D-412
Tensile Strength (Break)	3,800 psi	ASTM D-412
Tensile Elongation (Break)	450%	ASTM D-412
Shore Hardness	90 A/47 D Shore	ASTM D-2240

### CHARACTERISTICS:

- Inherently Static Dissipative
- Melting Temperature: 355 °F
- Ultra-clean: low off-gassing and low ionic contamination
- Rated for 75 °C repeated use
- Available Gauges: .125-.150

### **APPLICATIONS:**

- Medical device packaging
- Electronic component handling
- Hard disk drive component packaging
- Superior cushioning

#### All values are for pre-formed materials. Electrical values will vary with each individual design.

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